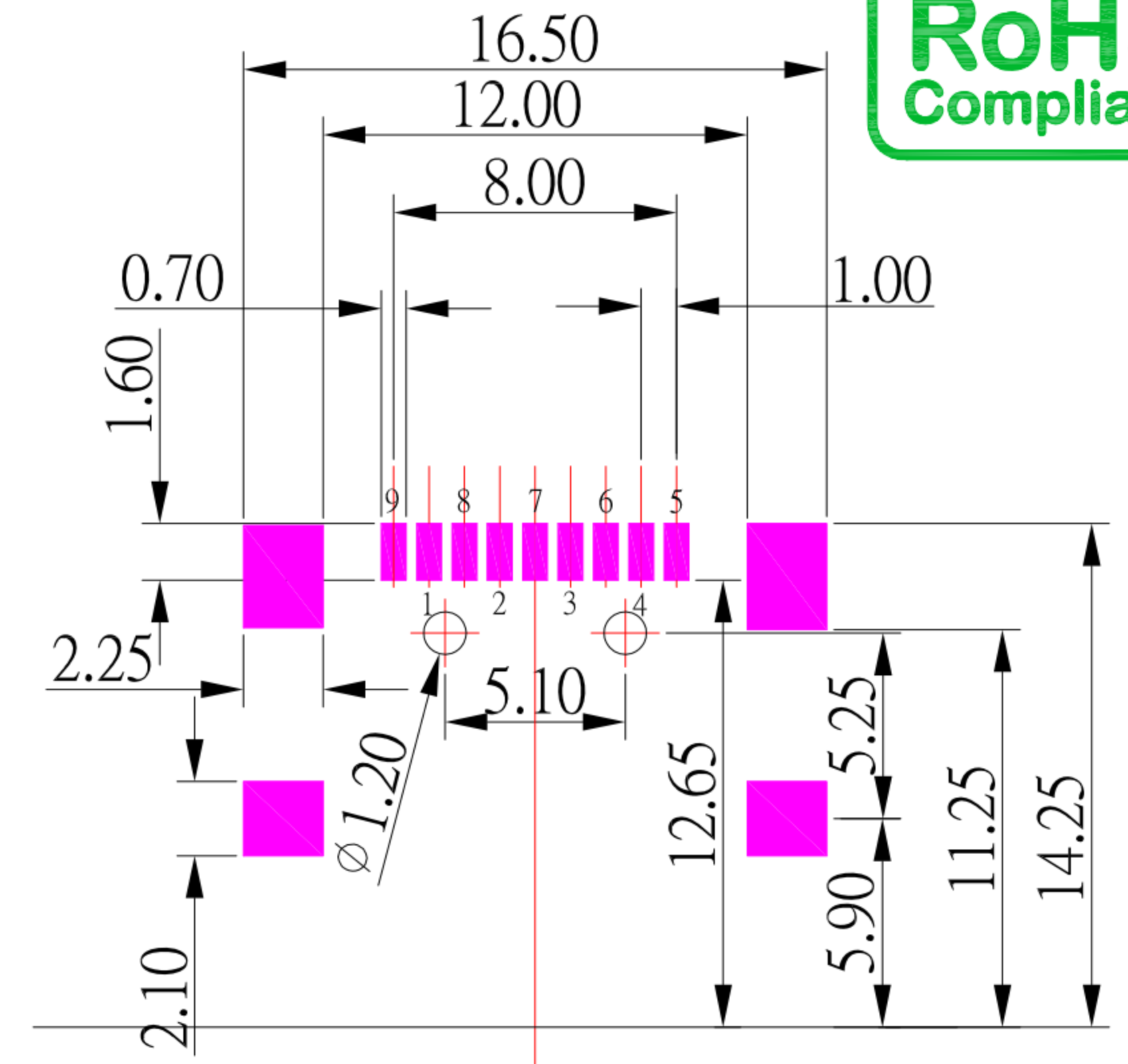




SUA-110M8A-30x-S372

— 鍍層厚度：

Blank : 1u"
2 : 15u"
3 : 30u"

NOTE:

1.MATERIAL:

1.1 Housing: LCP

1.2 Contact: Phosphor Bronze

1.3 Shell: Brass

2.Finish:

2.1 Contact: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall

2.2 Shell: Nickel under Plated surface layer

3.SPECIFICATION:

3.1 Current Rate: 1.5 A

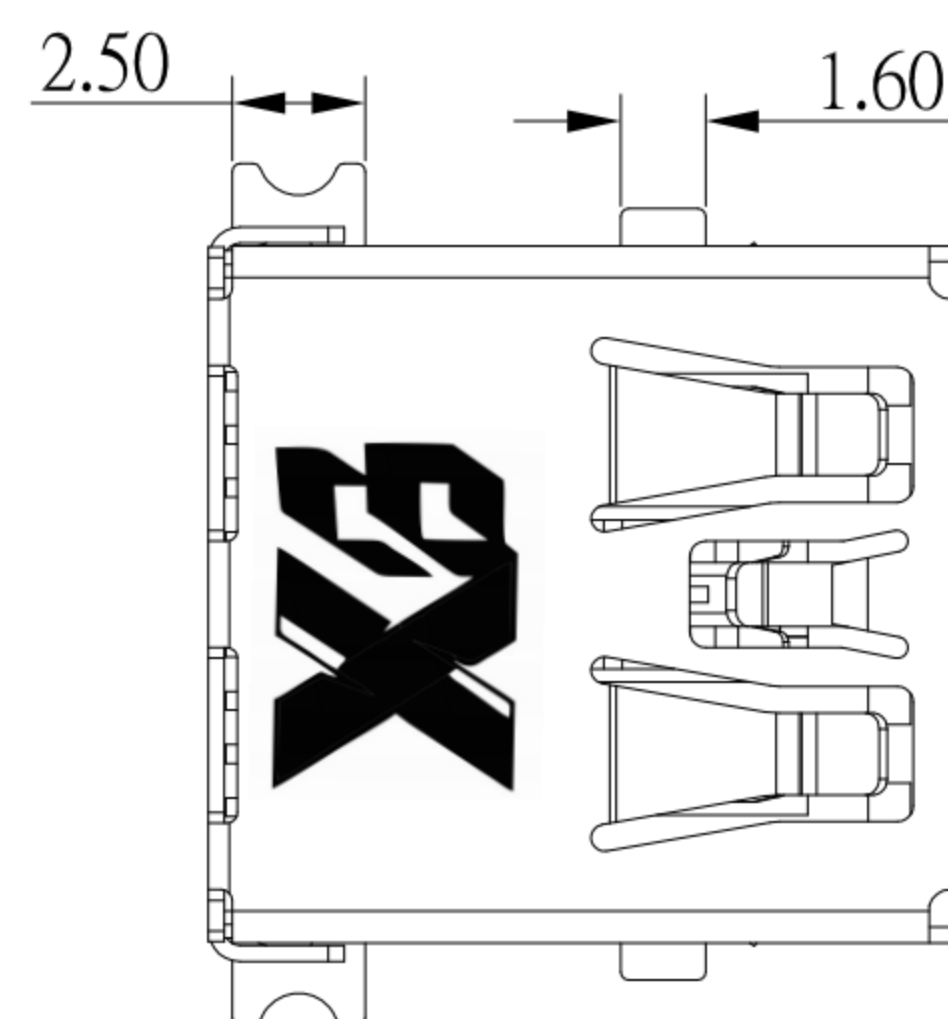
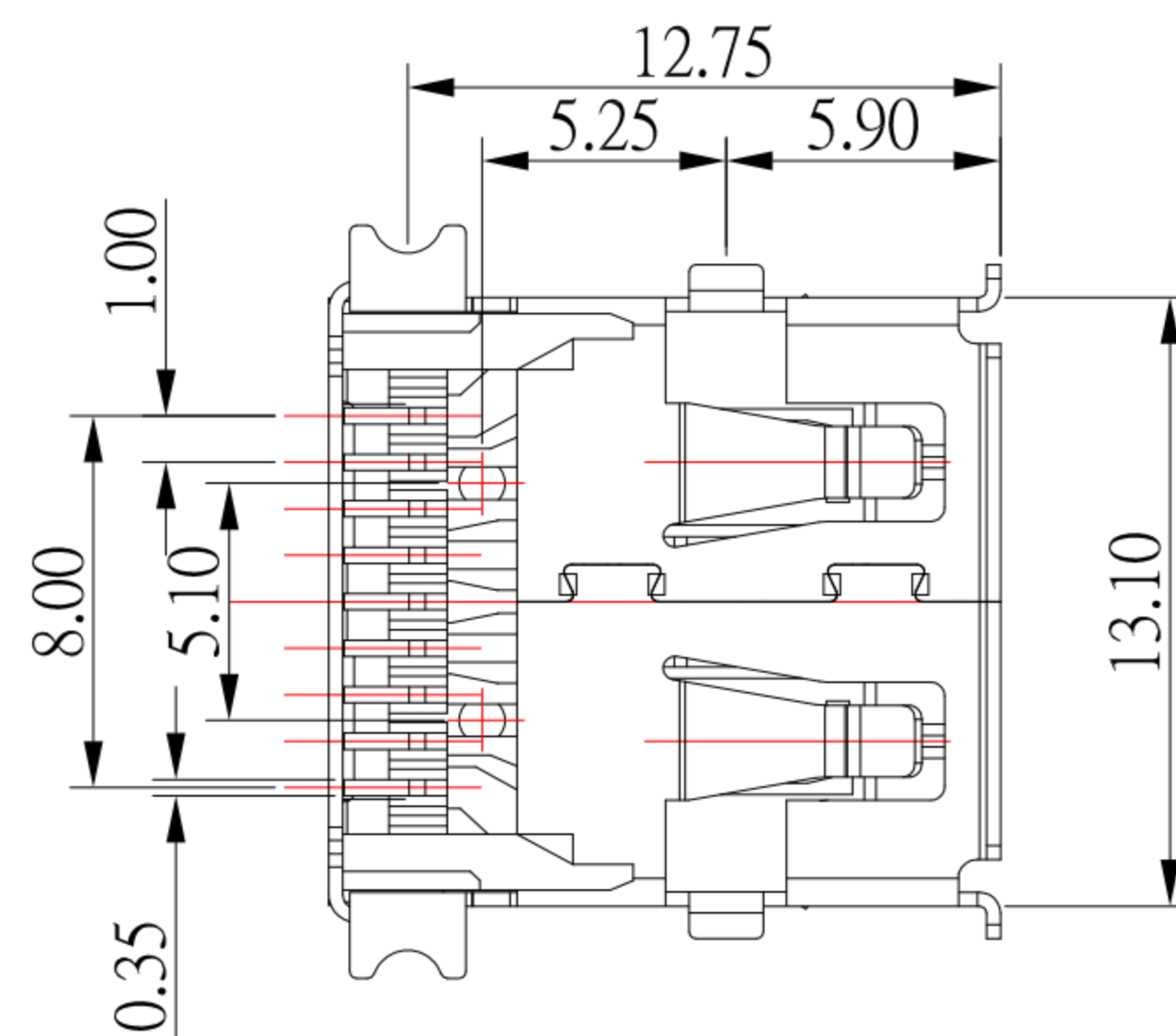
3.2 insulator Resistance:100M Ω Min

3.3 Dielectric Strength: 100V AC

3.4 Contact Resistance: 30mΩ Max

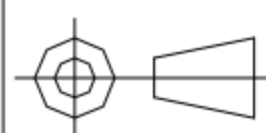
3.5 Operation Temperature: -40°C ~ +85°C

Pin NUMBER	SIGNAL NAME
1	VBUS
2	D-
3	D+
4	GND
5	StdA_SSRX-
6	StdA_SSRX+
7	GND_DRAIN
8	StdA_SSTX-
9	StdA_SSTX+
Shell	Shield



TOLERANCE UNLESS OTHERWISE STATED :	Up to 5	± 0.2
	Above 5 ~ 15	± 0.3
	Above 15 ~ 30	± 0.4
	Above 30 ~ 50	± 0.5
	Angle	± 0.3

3RD.
ANGEL'S



UNITS

MM

DRAWN BY:	DATE
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Jack Lu	03/23/23
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CHECKED BY:	DATE
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Jacky Chen	03/23/23
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APPROVED BY:	DATE
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MAT'L.

FINISH

SCALE

SHEET NO.

TITLE

MODLE

DWG NO

PART NO

CONNECTOR

USB 3.0 AF SMT 外殼四腳全貼本體長=14.60mm, 板上高7.0 有捲邊 有定位柱	7
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SUA-110M8A-30x-S372

SUA-110M8A-30x-S372

SIZE	
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Y4	
ER	

R